


CYPRESS
PRELIMINARY
CY7C09159
CY7C09169

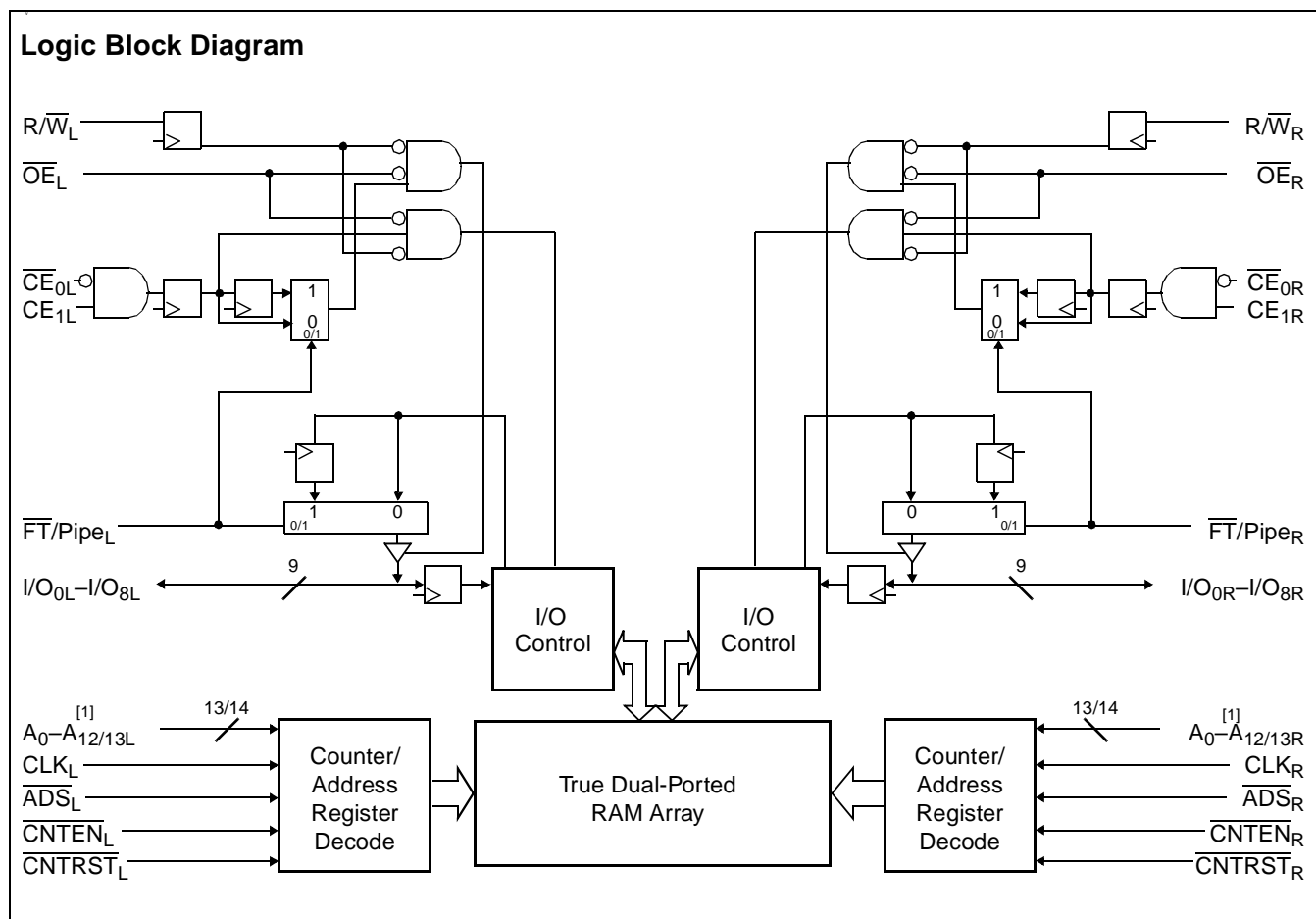
8K/16K x 9 Synchronous Dual-Port Static RAM

Features

- True Dual-Ported memory cells which allow simultaneous access of the same memory location
- 2 Flow-Through/Pipelined devices
 - 8K x 9 organization (CY7C09159)
 - 16K x 9 organization (CY7C09169)
- 3 Modes
 - Flow-Through
 - Pipelined
 - Burst
- Pipelined output mode on both ports allows fast 100-MHz cycle time
- 0.35-micron CMOS for optimum speed/power

- High-speed clock to data access 6.5/7.5/12 ns (max.)
- Low operating power
 - Active= 200 mA (typical)
 - Standby= 0.05 mA (typical)
- Fully synchronous interface for easier operation
- Burst counters increment addresses internally
 - Shorten cycle times
 - Minimize bus noise
 - Supported in Flow-Through and Pipelined modes
- Dual Chip Enables for easy depth expansion
- Automatic power-down
- Commercial and Industrial temperature ranges
- Available in 100-pin TQFP

Logic Block Diagram



Note:

1. A₀–A₁₂ for 8K; A₀–A₁₃ for 16K.

For the most recent information, visit the Cypress web site at www.cypress.com

Functional Description

The CY7C09159 and CY7C09169 are high speed synchronous CMOS 8K and 16K x 9 dual-port static RAMs. Two ports are provided, permitting independent, simultaneous access for reads and writes to any location in memory.^[2] Registers on control, address, and data lines allow for minimal set-up and hold times. In pipelined output mode, data is registered for decreased cycle time. Clock to data valid $t_{CD2} = 6.5$ ns (pipelined). Flow-through mode can also be used to bypass the pipelined output register to eliminate access latency. In flow-through mode data will be available $t_{CD1} = 15$ ns after the address is clocked into the device. Pipelined output or flow-through mode is selected via the FT/Pipe pin.

Each port contains a burst counter on the input address register. The internal write pulse width is independent of the LOW-to-HIGH transition of the clock signal. The internal write pulse is self-timed to allow the shortest possible cycle times.

A HIGH on \overline{CE}_0 or LOW on CE_1 for one clock cycle will power down the internal circuitry to reduce the static power consumption. The use of multiple Chip Enables allows easier banking of multiple chips for depth expansion configurations. In the pipelined mode, one cycle is required with \overline{CE}_0 LOW and CE_1 HIGH to reactivate the outputs.

Counter enable inputs are provided to stall the operation of the address input and utilize the internal address generated by the internal counter for fast interleaved memory applications. A port's burst counter is loaded with the port's address strobe (ADS). When the port's count enable (\overline{CNTEN}) is asserted, the address counter will increment on each LOW-to-HIGH transition of that port's clock signal. This will read/write one word from/into each successive address location until \overline{CNTEN} is deasserted. The counter can address the entire memory array and will loop back to the start. Counter reset (\overline{CNTRST}) is used to reset the burst counter.

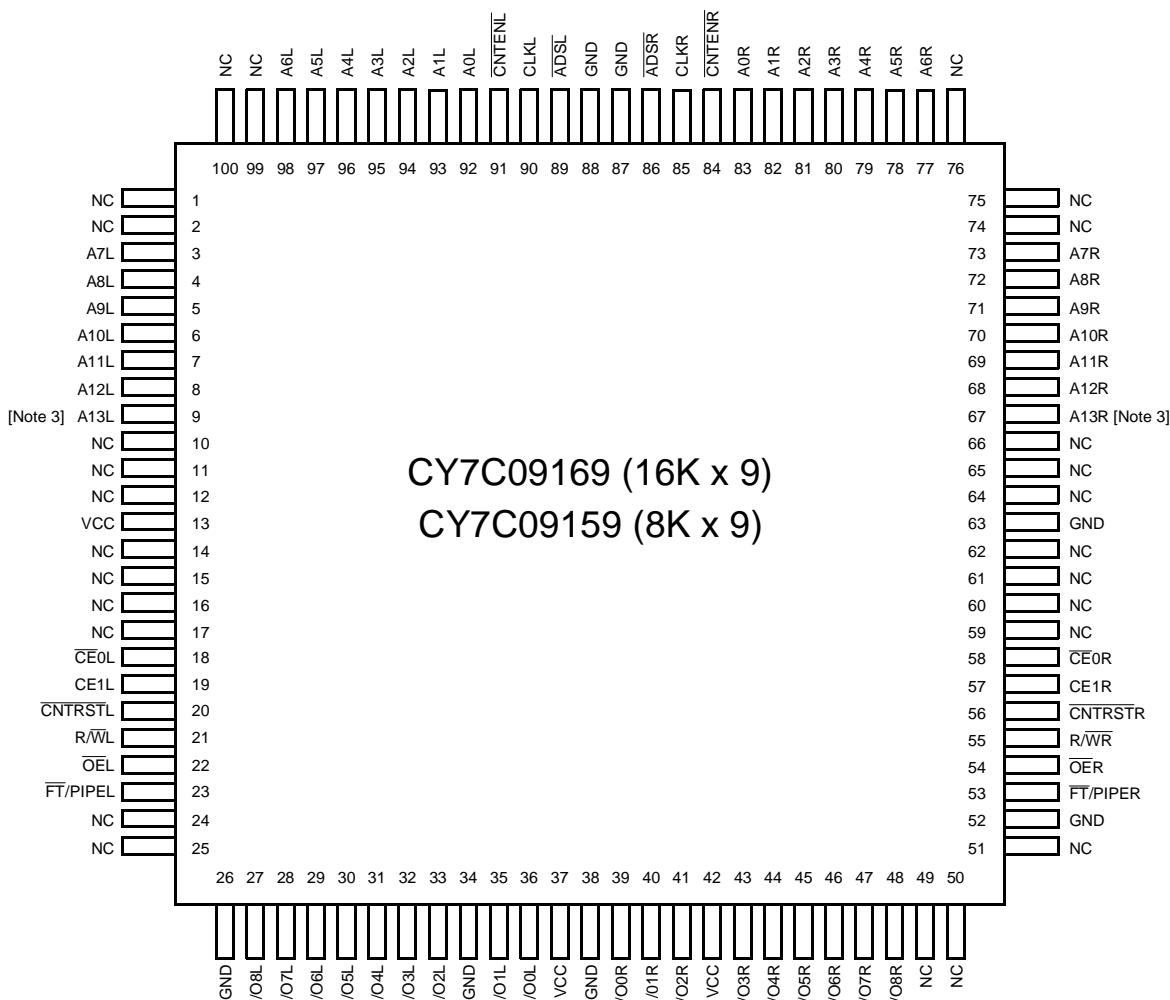
All parts are available in 100-pin Thin Quad Plastic Flatpack (TQFP) packages.

Note:

2. When simultaneously writing to the same location, final value cannot be guaranteed.

Pin Configurations

**100-Pin TQFP
(Top View)**



Note:

3. This pin is NC for CY7C09159.

Selection Guide

	CY7C09159 CY7C09169 -6	CY7C09159 CY7C09169 -7	CY7C09159 CY7C09169 -12
f_{MAX2} (MHz) (Pipelined)	100	83	50
Max Access Time (ns) (Clock to Data, Pipelined)	6.5	7.5	12
Typical Operating Current I_{CC} (mA)	250	235	195
Typical Standby Current for I_{SB1} (mA) (Both Ports TTL Level)	45	40	30
Typical Standby Current for I_{SB3} (mA) (Both Ports CMOS Level)	0.05	0.05	0.05

Pin Definitions

Left Port	Right Port	Description
$A_{0L}-A_{13L}$	$A_{0R}-A_{13R}$	Address Inputs. (A_0-A_{12} for 8K; A_0-A_{13} for 16K devices)
ADS_L	ADS_R	Address Strobe Input. Used as an address qualifier. This signal should be asserted LOW during normal read or write transactions. Asserting this signal LOW also loads the burst address counter with data present on the I/O pins.
$\overline{CE}_{0L}, CE_{1L}$	$\overline{CE}_{0R}, CE_{1R}$	Chip Enable Input. To select either the left or right port, both \overline{CE}_0 AND CE_1 must be asserted to their active states ($\overline{CE}_0 \leq V_{IL}$ and $CE_1 \geq V_{IH}$).
CLK_L	CLK_R	Clock Signal. This input can be free running or strobed. Maximum clock input rate is f_{MAX} .
$CNTEN_L$	$CNTEN_R$	Counter Enable Input. Asserting this signal LOW increments the burst address counter of its respective port on each rising edge of CLK. CNTEN is disabled if ADS or CNTRST are asserted LOW.
$CNTRST_L$	$CNTRST_R$	Counter Reset Input. Asserting this signal LOW resets the burst address counter of its respective port to zero. CNTRST is not disabled by asserting ADS or CNTEN.
$I/O_{0L}-I/O_{8L}$	$I/O_{0R}-I/O_{8R}$	Data Bus Input/Output ($I/O_0-I/O_7$ for x8 devices; $I/O_0-I/O_8$ for x9 devices).
OE_L	OE_R	Output Enable Input. This signal must be asserted LOW to enable the I/O data pins during read operations.
R/W_L	R/W_R	Read/Write Enable Input. This signal is asserted LOW to write to the dual port memory array. For read operations, assert this pin HIGH.
$FT/PIPE_L$	$FT/PIPE_R$	Flow-Through/Pipelined Select Input. For flow-through mode operation, assert this pin LOW. For pipelined mode operation, assert this pin HIGH.
GND		Ground Input.
NC		No Connect.
V_{CC}		Power Input.

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to $+150^{\circ}\text{C}$

Ambient Temperature with Power Applied .. -55°C to $+125^{\circ}\text{C}$

Supply Voltage to Ground Potential -0.3V to $+7.0\text{V}$

DC Voltage Applied to
Outputs in High Z State -0.5V to $+7.0\text{V}$

DC Input Voltage -0.5V to $+7.0\text{V}$

Output Current into Outputs (LOW) 20 mA

Static Discharge Voltage $>2001\text{V}$

Latch-Up Current $>200\text{ mA}$

Operating Range

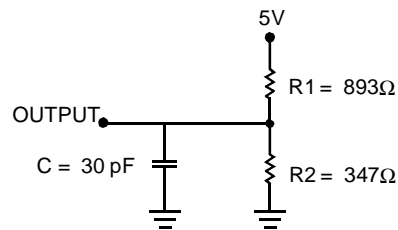
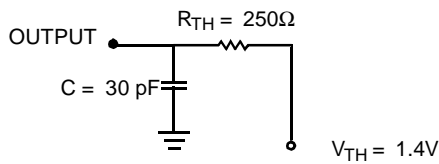
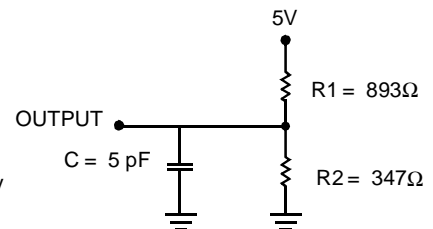
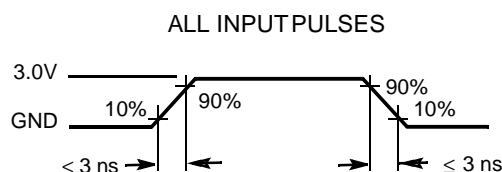
Range	Ambient Temperature	V_{CC}
Commercial	0°C to $+70^{\circ}\text{C}$	$5\text{V} \pm 10\%$
Industrial	-40°C to $+85^{\circ}\text{C}$	$5\text{V} \pm 10\%$

Electrical Characteristics Over the Operating Range

Symbol	Parameter		CY7C09159 CY7C09169									Units
			-6			-7			-12			
			Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V _{OH}	Output HIGH Voltage (V _{CC} =Min, I _{OH} =−4.0 mA)		2.4			2.4			2.4		V	
V _{OL}	Output LOW Voltage (V _{CC} =Min, I _{OH} = +4.0 mA)				0.4			0.4			0.4	V
V _{IH}	Input HIGH Voltage		2.2			2.2			2.2			V
V _{IL}	Input LOW Voltage				0.8			0.8			0.8	V
I _{OZ}	Output Leakage Current		−10		10	−10		10	−10		10	μA
I _{CC}	Operating Current (V _{CC} =Max, I _{OUT} =0 mA) Outputs Disabled	Com'l.		250	450		235	420		195	300	mA
		Indust.					260	445		225	375	mA
I _{SB1}	Standby Current (Both Ports TTL Level) ^[4] \overline{CE}_L & $\overline{CE}_R \geq V_{IH}$, f=f _{MAX}	Com'l.		45	115		40	105		30	85	mA
		Indust.					55	120		45	100	mA
I _{SB2}	Standby Current (One Port TTL Level) ^[4] \overline{CE}_L $\overline{CE}_R \geq$ V _{IH} , f=f _{MAX}	Com'l.		175	235		160	220		125	190	mA
		Indust.					175	235		140	205	mA
I _{SB3}	Standby Current (Both Ports CMOS Level) ^[4] \overline{CE}_L & $\overline{CE}_R \geq V_{CC} - 0.2V$, f=0	Com'l.		0.05	0.25		0.05	0.25		0.05	0.25	mA
		Indust.					0.05	0.25		0.05	0.25	mA
I _{SB4}	Standby Current (One Port CMOS Level) ^[4] \overline{CE}_L \overline{CE}_R $\geq V_{IH}$, f=f _{MAX}	Com'l.		160	200		145	185		110	150	mA
		Indust.					160	200		125	165	mA

Capacitance

Parameter	Description	Test Conditions	Max.	Unit
C_{IN}	Input Capacitance	$T_A = 25^\circ\text{C}$, $f = 1 \text{ MHz}$, $V_{CC} = 5.0 \text{ V}$	10	pF
C_{OUT}	Output Capacitance		10	pF

AC Test Loads

(a) Normal Load (Load 1)

(b) Thévenin Equivalent (Load 1)

(c) Three-State Delay (Load 2)
(Used for t_{CKLZ} , t_{OLZ} , & t_{OHZ} including scope and jig)

Note:

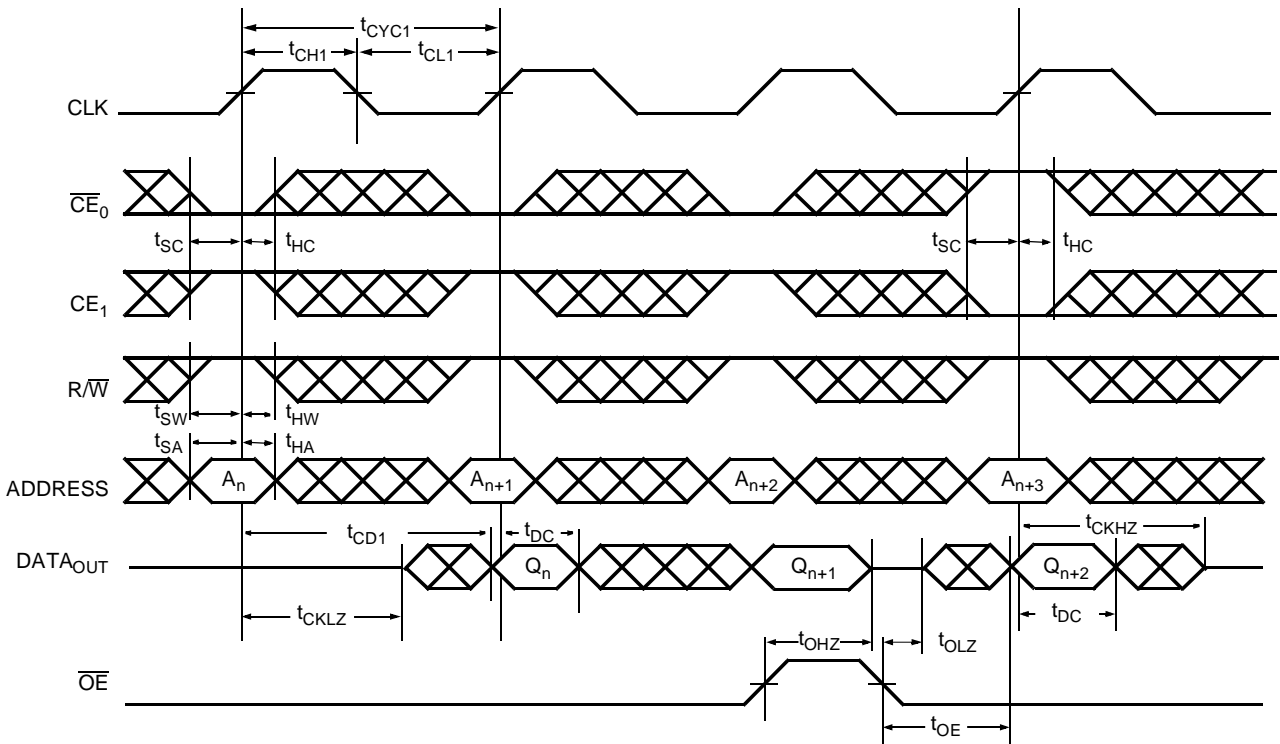
4. \overline{CE}_L and \overline{CE}_R are internal signals. To select either the left or right port, both \overline{CE}_0 AND \overline{CE}_1 must be asserted to their active states ($\overline{CE}_0 \leq V_{IL}$ and $\overline{CE}_1 \geq V_{IH}$).

Switching Characteristics Over the Operating Range

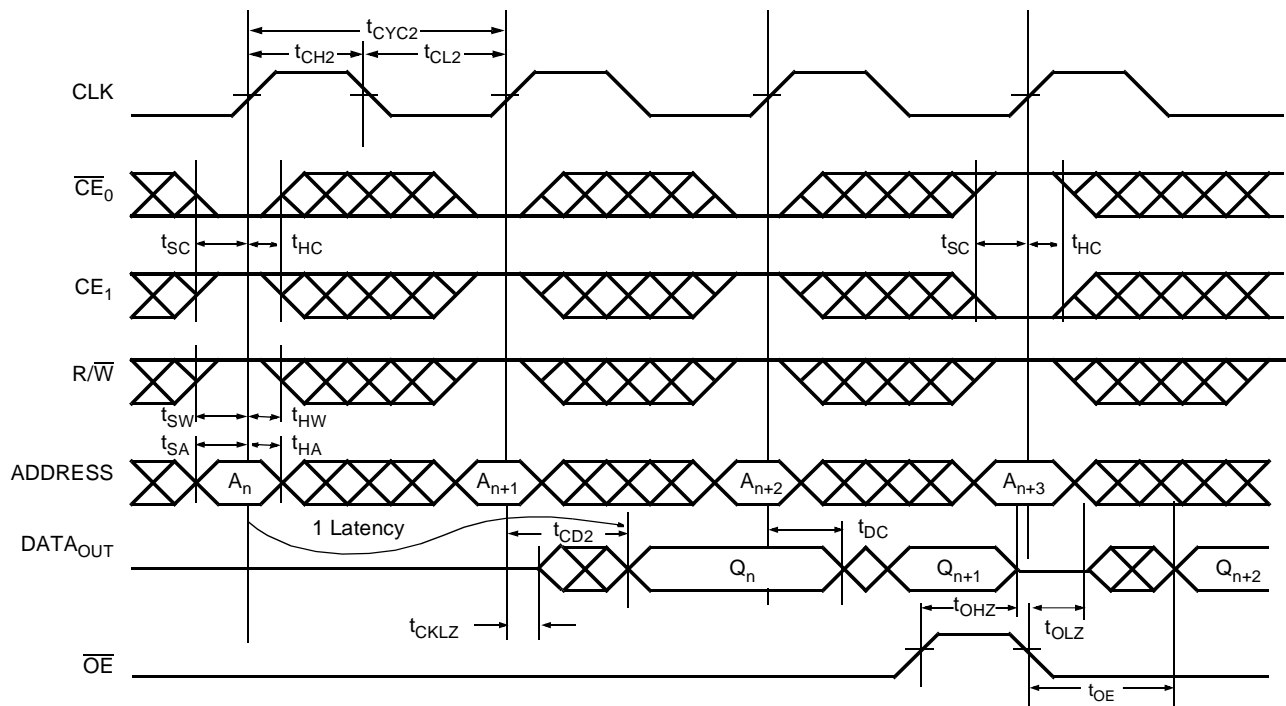
Symbol	Parameter	CY7C09159 CY7C09169						Units
		-6		-7		-12		
		Min	Max	Min	Max	Min	Max	
f _{MAX1}	f _{Max} Flow-Through		53		45		33	MHz
f _{MAX2}	f _{Max} Pipelined		100		83		50	MHz
t _{CYC1}	Clock Cycle Time - Flow-Through	19		22		30		ns
t _{CYC2}	Clock Cycle Time - Pipelined	10		12		20		ns
t _{CH1}	Clock HIGH Time - Flow-Through	6.5		7.5		12		ns
t _{CL1}	Clock LOW Time - Flow-Through	6.5		7.5		12		ns
t _{CH2}	Clock HIGH Time - Pipelined	4		5		8		ns
t _{CL2}	Clock LOW Time - Pipelined	4		5		8		ns
t _R	Clock Rise Time		3		3		3	ns
t _F	Clock Fall Time		3		3		3	ns
t _{SA}	Address Set-up Time	3.5		4		4		ns
t _{HA}	Address Hold Time	0		0		1		ns
t _{SC}	Chip Enable Set-up Time	3.5		4		4		ns
t _{HC}	Chip Enable Hold Time	0		0		1		ns
t _{SW}	R/ \overline{W} Set-up Time	3.5		4		4		ns
t _{HW}	R/W Hold Time	0		0		1		ns
t _{SD}	Input Data Set-up Time	3.5		4		4		ns
t _{HD}	Input Data Hold Time	0		0		1		ns
t _{SAD}	\overline{ADS} Set-up Time	3.5		4		4		ns
t _{HAD}	\overline{ADS} Hold Time	0		0		1		ns
t _{SCN}	\overline{CNTEN} Set-up Time	3.5		4		4		ns
t _{HCN}	\overline{CNTEN} Hold Time	0		0		1		ns
t _{SRST}	\overline{CNTRST} Set-up Time	3.5		4		4		ns
t _{HRST}	\overline{CNTRST} Hold Time	0		0		1		ns
t _{OE}	Output Enable to Data Valid		8		9		12	ns
t _{OLZ}	\overline{OE} to Low Z	2		2		2		ns
t _{OHZ}	\overline{OE} to High Z	1	7	1	7	1	7	ns
t _{CD1}	Clock to Data Valid - Flow-Through		15		18		25	ns
t _{CD2}	Clock to Data Valid - Pipelined		6.5		7.5		12	ns
t _{DC}	Data Output Hold After Clock HIGH	2		2		2		ns
t _{CKHZ}	Clock HIGH to Output High Z	2	9	2	9	2	9	ns
t _{CKLZ}	Clock HIGH to Output Low Z	2		2		2		ns
Port to Port Delays								
t _{CWDD}	Write Port Clock HIGH to Read Data Delay		30		35		40	ns
t _{CCS}	Clock to Clock Set-up Time		9		10		15	ns

Switching Waveforms

Read Cycle for Flow-Through Output ($\overline{\text{FT}}/\text{PIPE} = V_{\text{IL}}$)^[5,6,7,8]

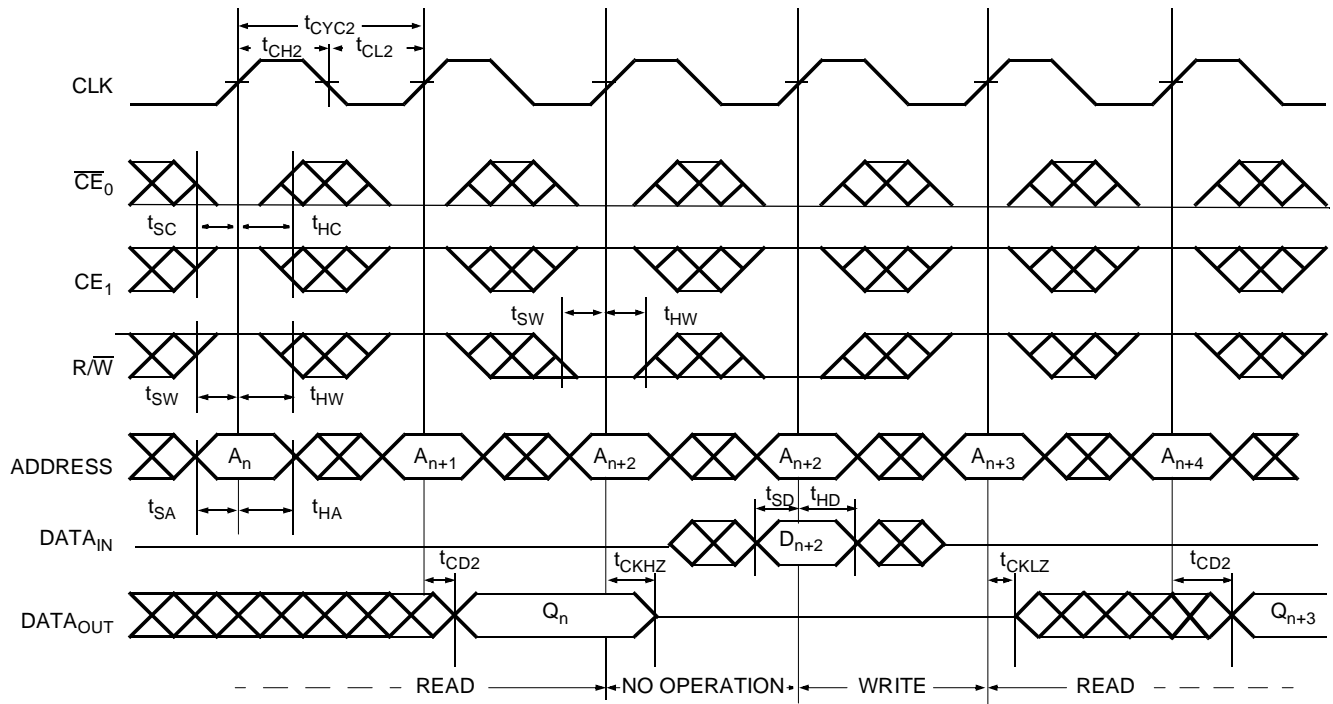
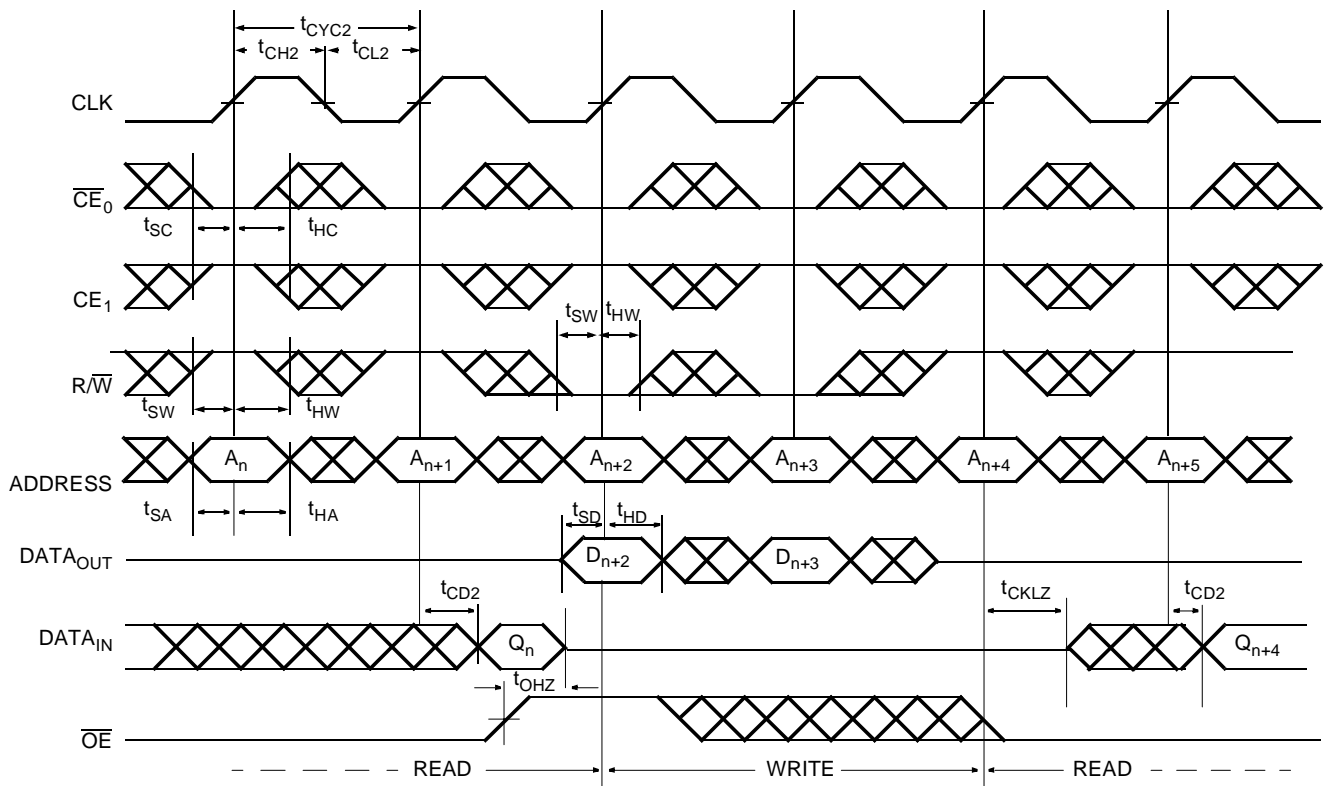


Read Cycle for Pipelined Operation ($\overline{\text{FT}}/\text{PIPE} = V_{\text{IH}}$)^[5,6,7,8]

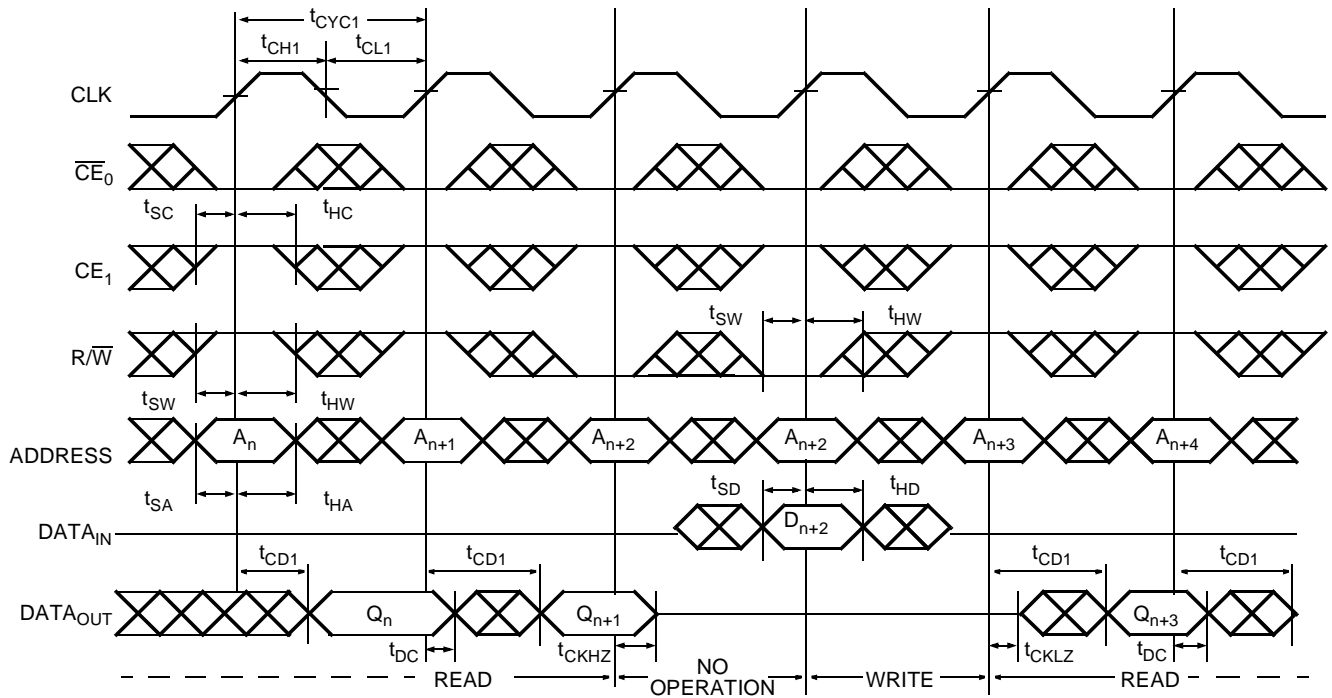
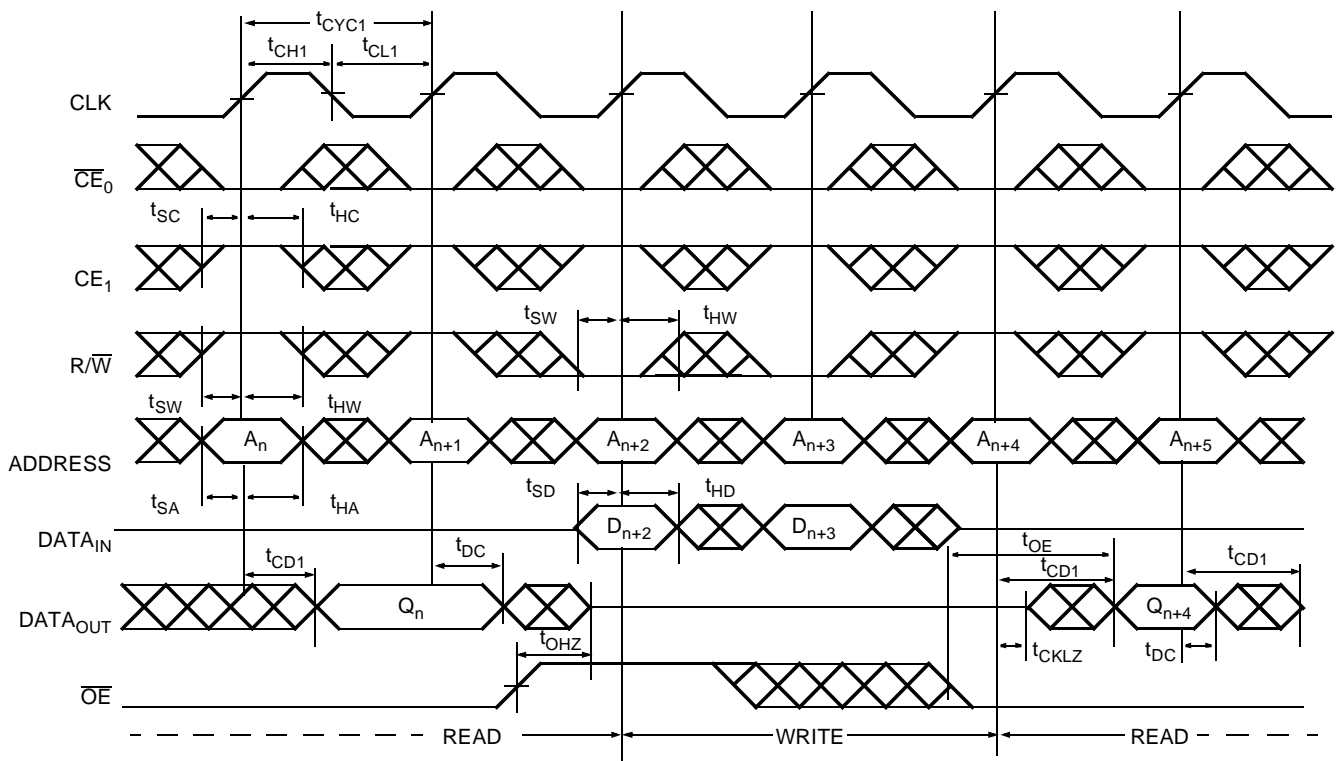


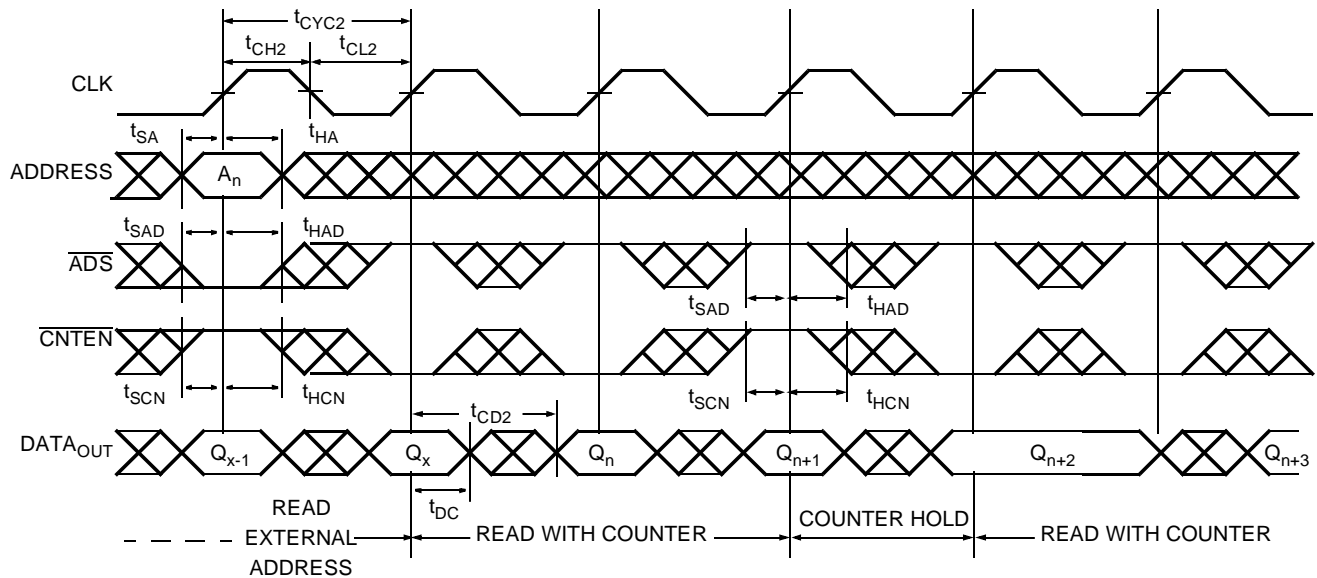
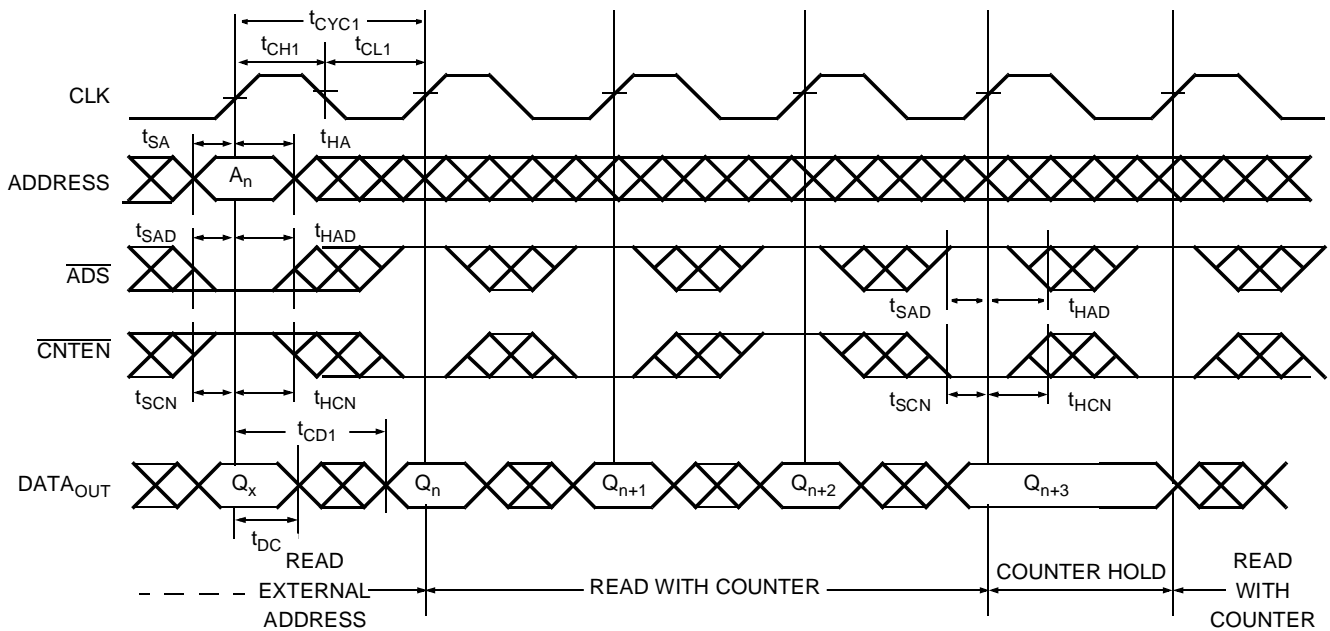
Notes:

5. $\overline{\text{OE}}$ is asynchronously controlled; all other inputs are synchronous to the rising clock edge.
6. $\text{ADS} = V_{\text{IL}}$, CNTEN and $\text{CNTRST} = V_{\text{IH}}$.
7. The output is disabled (high-impedance state) by $\overline{\text{CE}}_0 = V_{\text{IH}}$ or $\text{CE}_1 = V_{\text{IL}}$ following the next rising edge of the clock.
8. Addresses do not have to be accessed sequentially since $\text{ADS} = V_{\text{IL}}$ constantly loads the address on the rising edge of the CLK. Numbers are for reference only.

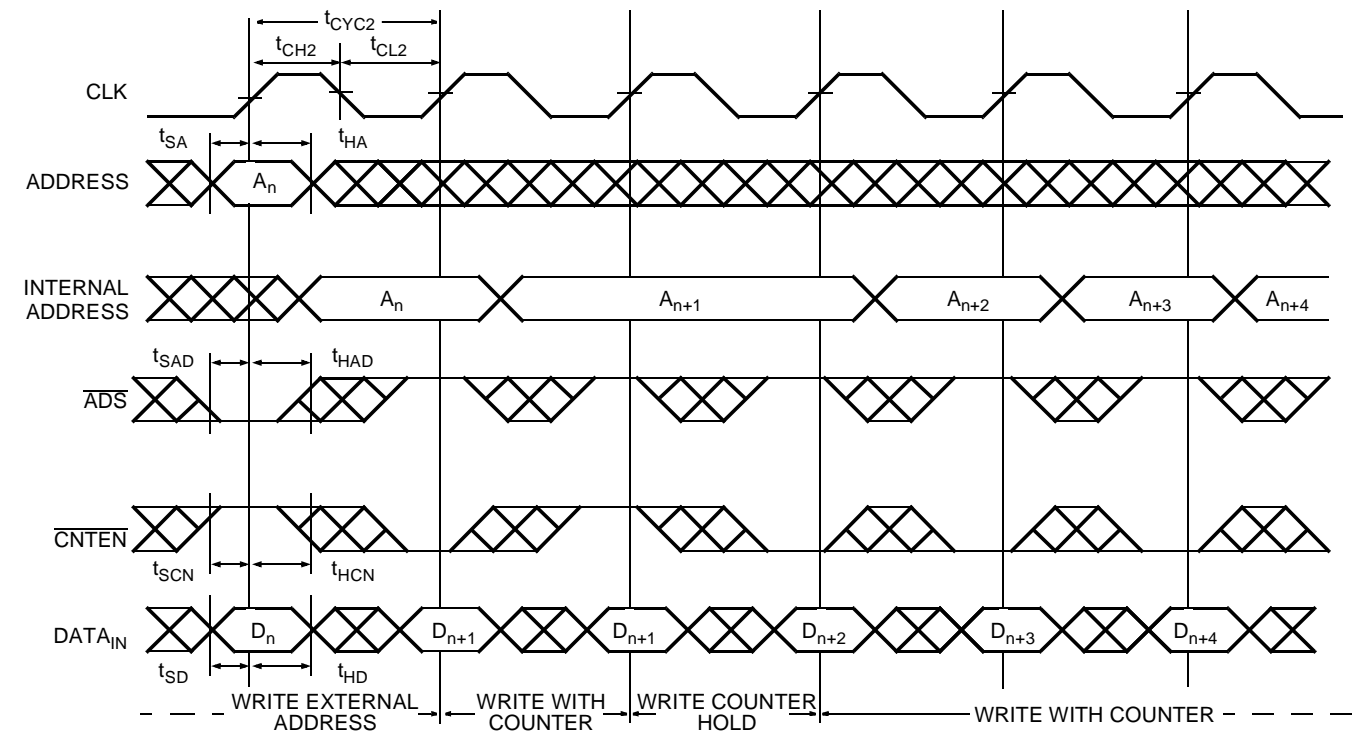
Switching Waveforms (continued)
Pipelined Read-to-Write-to-Read ($\overline{OE} = V_{IL}$)^[8,12,15,16]

Pipelined Read-to-Write-to-Read (\overline{OE} Controlled)^[8,12,15,16]

Notes:

15. Output state (HIGH, LOW, or High-Impedance) is determined by the previous cycle control signals.
16. During "No operation", data in memory at the selected address may be corrupted and should be re-written to ensure data integrity.

Switching Waveforms (continued)
Flow-Through Read-to-Write-to-Read ($\overline{OE} = V_{IL}$)^[6,8,12,15]

Flow-Through Read-to-Write-to-Read (\overline{OE} Controlled)^[6,8,12,15]


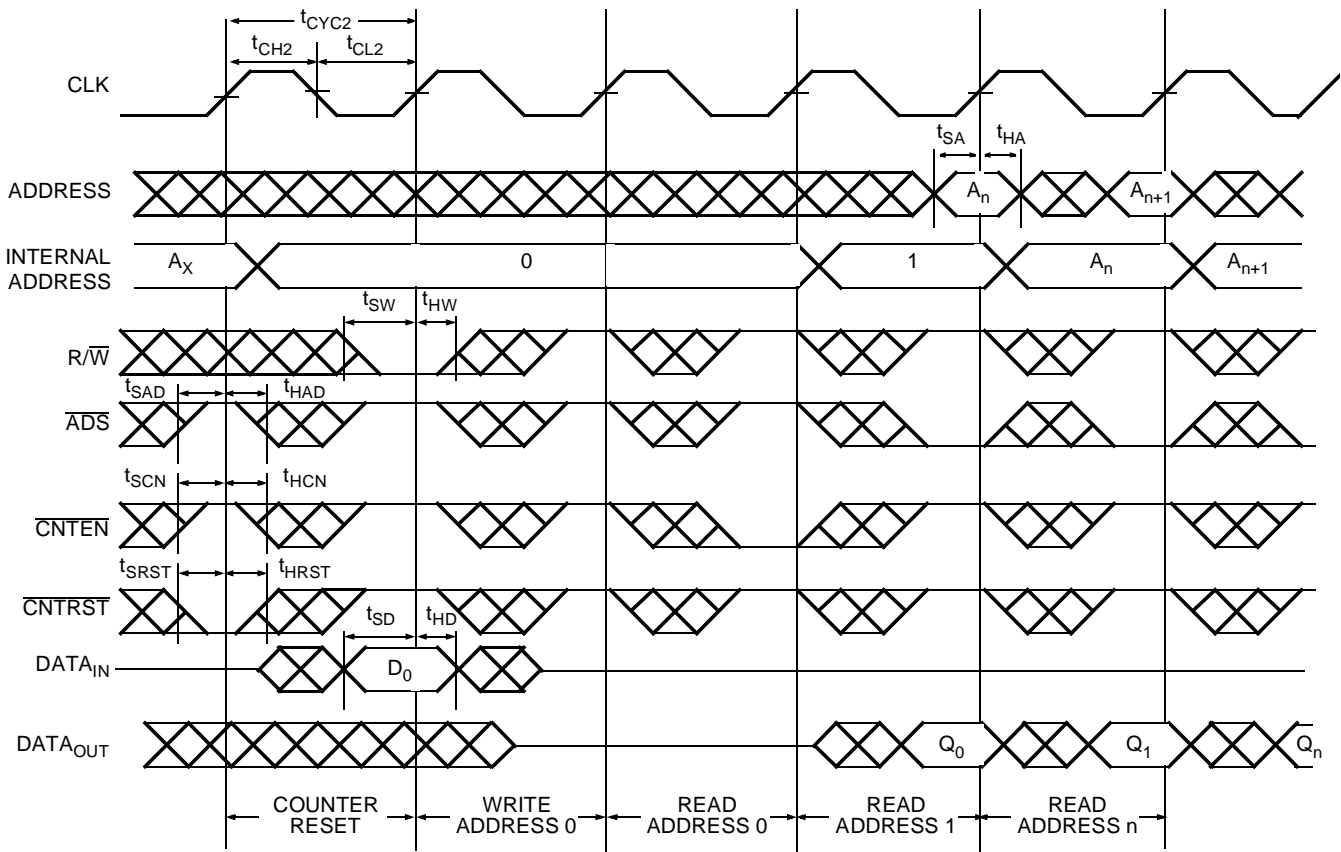
Switching Waveforms (continued)
Pipelined Read with Address Counter Advance^[17]

Flow-Through Read with Address Counter Advance^[17]

Note:

17. \overline{CE}_0 and $\overline{OE} = V_{IL}$; \overline{CE}_1 , $\overline{R\overline{W}}$ and $\overline{CNTRST} = V_{IH}$.

Switching Waveforms (continued)
Write with Address Counter Advance (Flow-Through or Pipelined Outputs)^[18,19]

Notes:

18. $\overline{CE_0}$ and $R/\overline{W} = V_{IL}$; $\overline{CE_1}$ and $\overline{CNTRST} = V_{IH}$.





19. The "Internal Address" is equal to the "External Address" when $\overline{ADS} = V_{IL}$ and equals the counter output when $\overline{ADS} = V_{IH}$.

Switching Waveforms (continued)
Counter Reset (Pipelined Outputs)^[8,15,20,21]

Notes:





20. $\overline{CE}_0 = V_{IL}$; $CE_1 = V_{IH}$.

21. No dead cycle exists during counter reset. A READ or WRITE cycle may be coincidental with the counter reset.

Read/Write and Enable Operation^[22,23,24]

Inputs					Outputs	Operation
\overline{OE}	CLK	\overline{CE}_0	CE_1	R/W	I/O ₀ –I/O ₈	
X		H	X	X	High-Z	Deselected ^[25]
X		X	L	X	High-Z	Deselected ^[25]
X		L	H	L	D _{IN}	Write
L		L	H	H	D _{OUT}	Read ^[25]
H	X	L	H	X	High-Z	Outputs Disabled

Address Counter Control Operation^[22,26,27,28]

Address	Previous Address	CLK	\overline{ADS}	\overline{CNTEN}	\overline{CNTRST}	I/O	Mode	Operation
X	X		X	X	L	D _{out(0)}	Reset	Counter Reset to Address 0
A _n	X		L	X	H	D _{out(n)}	Load	Address Load into Counter
X	A _n		H	H	H	D _{out(n)}	Hold	External Address Blocked—Counter Disabled
X	A _n		H	L	H	D _{out(n+1)}	Increment	Counter Enabled—Internal Address Generation

Notes:

22. "X" = Don't Care, "H" = V_{IH}, "L" = V_{IL}.
23. \overline{ADS} , \overline{CNTEN} , \overline{CNTRST} = Don't Care.
24. \overline{OE} is an asynchronous input signal.
25. When \overline{CE} changes state in the pipelined mode, deselection and read happen in the following clock cycle.
26. \overline{CE}_0 and \overline{OE} = V_{IL}; CE_1 and R/W = V_{IH}.
27. Data shown for Flow-through mode; pipelined mode output will be delayed by one cycle.
28. Counter operation is independent of \overline{CE}_0 and CE_1 .

Ordering Information

8K x9 Synchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
6.5	CY7C09159-6AC	A100	100-Pin Thin Quad Flat Pack	Commercial
7.5	CY7C09159-7AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C09159-7AI	A100	100-Pin Thin Quad Flat Pack	Industrial
12	CY7C09159-12AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C09159-12AI	A100	100-Pin Thin Quad Flat Pack	Industrial

16K x9 Synchronous Dual-Port SRAM

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
6.5	CY7C09169-6AC	A100	100-Pin Thin Quad Flat Pack	Commercial
7.5	CY7C09169-7AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C09169-7AI	A100	100-Pin Thin Quad Flat Pack	Industrial
12	CY7C09169-12AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C09169-12AI	A100	100-Pin Thin Quad Flat Pack	Industrial

Document #: 38-00671-B

Package Diagram

100-Pin Thin Quad Flat Pack A100

